

P-Channel Enhancement Mode Power MOSFET

Description

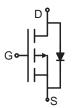
The RM1216 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages .This device is suitable for use as a load switching application and a wide variety of other applications.

General Features

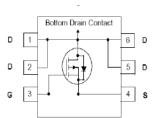
- $V_{DS} = -12V, I_D = -16A$ $R_{DS(ON)} < 22m\Omega @ V_{GS} = -2.5V$ $R_{DS(ON)} < 18m\Omega @ V_{GS} = -4.5V$
- Advanced trench MOSFET process technology
- Ultra low on-resistance with low gate charge

Application

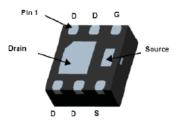
- PWM applications
- Load switch
- Battery charge in cellular handset



Schematic diagram



Pin assignment



DFN2X2-6L bottom view

Package marking and ordering information

| Device Marking | Device | Device Package | Reel Size | Tape Width | Quantity |
|----------------|--------|----------------|-----------|------------|----------|
| 1216 | RM1216 | DFN2X2-6L | - | - | - |

Absolute maximum ratings (T_c=25°C unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|--|----------------------------------|------------|------|
| Drain-Source Voltage | Vds | -12 | V |
| Gate-Source Voltage | Vgs | ±12 | V |
| Drain Current-Continuous | I _D | -16 | A |
| Drain Current -Pulsed (Note 1) | I _{DM} | -65 | A |
| Maximum Power Dissipation | P _D | 18 | W |
| Operating Junction and Storage Temperature Range | T _J ,T _{STG} | -55 To 150 | °C |

Thermal Characteristic

| Thermal Resistance, Junction-to-Case (Note 2) | R _{θJC} | 6.9 | °C/W |
|---|------------------|-----|------|
|---|------------------|-----|------|

| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|------------------------------------|-----------------------|---|------|------|------|------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | V _(BR) dss | V _{GS} =0V I _D =-250µA | -12 | - | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =-12V,V _{GS} =0V | - | - | -1 | μA |
| Gate-Body Leakage Current | I _{GSS} | $V_{GS}=\pm 12V, V_{DS}=0V$ | - | - | ±100 | nA |
| On Characteristics (Note 3) | I | | • | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS}=V_{GS}$, $I_{D}=-250\mu A$ | -0.4 | -0.7 | -1 | V |
| Durain Courses On State Desistence | P | V_{GS} =-4.5V, I _D =-6.7A | - | 11.5 | 18 | mΩ |
| Drain-Source On-State Resistance | R _{DS(ON)} | R _{DS(ON)} V _{GS} =-2.5V, I _D =-6.2A | - | 14 | 22 | mΩ |
| Forward Transconductance | g fs | V _{DS} =-5V,I _D =-6.7A | 20 | - | - | S |
| Dynamic Characteristics (Note4) | · · · | | • | • | | |
| Input Capacitance | C _{lss} | | - | 2700 | - | PF |
| Output Capacitance | C _{oss} | V _{DS} =-10V,V _{GS} =0V, F=1.0MHz | - | 680 | - | PF |
| Reverse Transfer Capacitance | C _{rss} | | - | 590 | - | PF |
| Switching Characteristics (Note 4) | | | | | | |
| Turn-on Delay Time | t _{d(on)} | | - | 11 | - | nS |
| Turn-on Rise Time | tr | V _{DD} =-10V,I _D =-1A | - | 35 | - | nS |
| Turn-Off Delay Time | t _{d(off)} | V_{GS} =-4.5V, R_{GEN} =10 Ω | - | 30 | - | nS |
| Turn-Off Fall Time | t _f | | - | 10 | - | nS |
| Total Gate Charge | Qg | | - | 35 | 48 | nC |
| Gate-Source Charge | Q _{gs} | V_{DS} =-6V,I _D =-10A, | - | 5 | - | nC |
| Gate-Drain Charge | Q _{gd} | V_{GS} =-4.5V | - | 10 | - | nC |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage (Note 3) | V _{SD} | V _{GS} =0V,I _S =-8A | - | - | -1.2 | V |
| Diode Forward Current (Note 2) | I _S | | - | - | -16 | А |

Electrical characteristics (T_A=25[°]C unless otherwise noted)

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t \leq 10 sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production



RATING AND CHARACTERISTICS CURVES (RM1216)

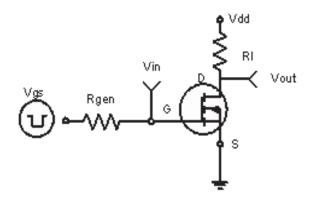
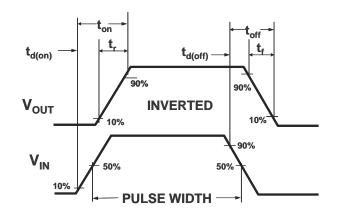
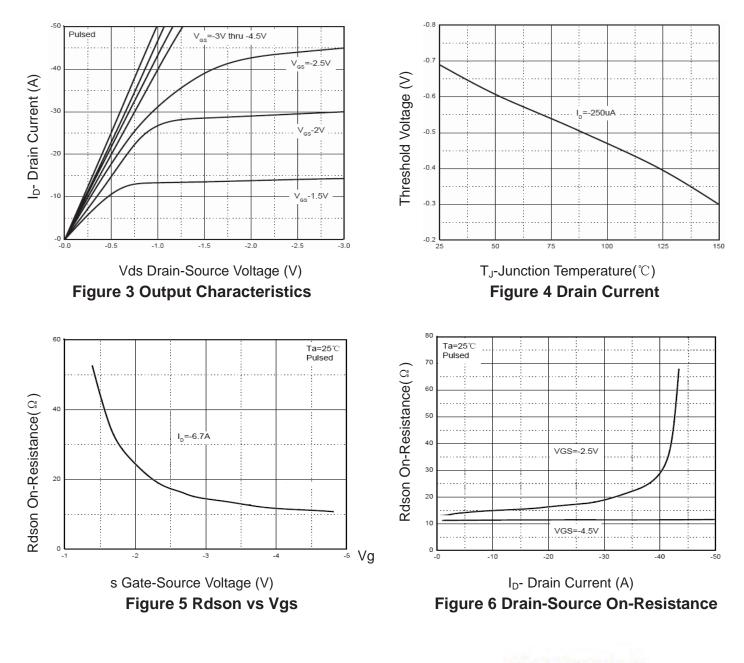


Figure 1:Switching Test Circuit







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RATING AND CHARACTERISTICS CURVES (RM1216)

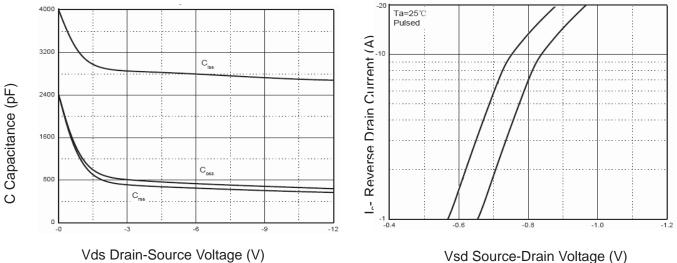
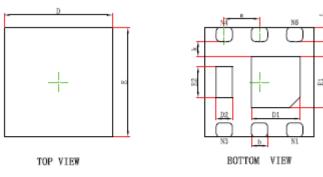


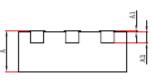
Figure 7 Capacitance vs Vds

Vsd Source-Drain Voltage (V) Figure 8 Source- Drain Diode Forward



DFN2X2-6L Package Information





| ST | DF. | VI | EW |
|----|-----|----|------|
| | 222 | | 22.0 |

| Symbol | Dimensions In Millimeters | | Dimensions In Inches | | |
|--------|---------------------------|-------|----------------------|-------|--|
| Symbol | Min. | Max. | Min. | Max. | |
| A | 0.700 | 0.800 | 0.028 | 0.031 | |
| A1 | 0.000 | 0.050 | 0.000 | 0.002 | |
| A3 | 0.203REF. | | 0.008 | REF. | |
| D | 1.924 | 2.076 | 0.076 | 0.082 | |
| E | 1.924 | 2.076 | 0.076 | 0.082 | |
| D1 | 0.800 | 1.000 | 0.031 | 0.039 | |
| E1 | 0.850 | 1.050 | 0.033 | 0.041 | |
| D2 | 0.200 | 0.400 | 0.008 | 0.016 | |
| E2 | 0.460 | 0.660 | 0.018 | 0.026 | |
| k | 0.200MIN. | | 0.008MIN. | | |
| b | 0.250 | 0.350 | 0.010 | 0.014 | |
| е | 0.650TYP. | | 0.026TYP. | | |
| L | 0.174 | 0.326 | 0.007 | 0.013 | |

Notes

- 1. All dimensions are in millimeters.
- 2. Tolerance ± 0.10 mm (4 mil) unless otherwise specified
- 3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
- 4. Dimension L is measured in gauge plane.
- 5. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.



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